



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# TrenchMV™ Power MOSFET

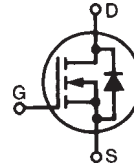
**IXTA220N075T**  
**IXTP220N075T**

$$V_{DSS} = 75 \text{ V}$$

$$I_{D25} = 220 \text{ A}$$

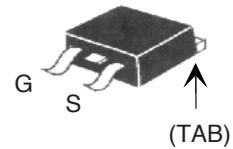
$$R_{DS(on)} \leq 4.5 \text{ m}\Omega$$

N-Channel Enhancement Mode  
Avalanche Rated

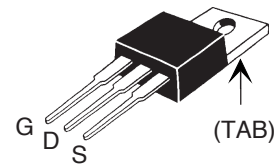


| Symbol     | Test Conditions   | Maximum Ratings |                  |
|------------|---|-----------------|------------------|
| $V_{DSS}$  | $T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$   | 75              | V                |
| $V_{DGR}$  | $T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$  | 75              | V                |
| $V_{GSM}$  | Transient   | $\pm 20$        | V                |
| $I_{D25}$  | $T_C = 25^\circ\text{C}$  | 220             | A                |
| $I_{LRMS}$ | Lead Current Limit, RMS   | 75              | A                |
| $I_{DM}$   | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$  | 600             | A                |
| $I_{AR}$   | $T_C = 25^\circ\text{C}$  | 25              | A                |
| $E_{AS}$   | $T_C = 25^\circ\text{C}$  | 1.0             | J                |
| $dv/dt$    | $I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$<br>$T_J \leq 175^\circ\text{C}$ , $R_G = 3.3 \Omega$ | 3               | V/ns             |
| $P_D$      | $T_C = 25^\circ\text{C}$  | 480             | W                |
| $T_J$      |   | -55 ... +175    | $^\circ\text{C}$ |
| $T_{JM}$   |   | 175             | $^\circ\text{C}$ |
| $T_{stg}$  |   | -55 ... +175    | $^\circ\text{C}$ |
| $T_L$      | 1.6 mm (0.062 in.) from case for 10 s   | 300             | $^\circ\text{C}$ |
| $T_{SOLD}$ | Plastic body for 10 seconds   | 260             | $^\circ\text{C}$ |
| $M_d$      | Mounting torque (TO-220)  | 1.13 / 10       | Nm/lb.in.        |
| Weight     | TO-220  | 3               | g                |
|            | TO-263  | 2.5             | g                |

TO-263 (IXTA)



TO-220 (IXTP)



G = Gate      D = Drain  
S = Source      TAB = Collector

### Features

- Ultra-low On Resistance
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect
- 175 °C Operating Temperature

### Advantages

- Easy to mount
- Space savings
- High power density

### Applications

- Automotive
  - Motor Drives
  - 42V Power Bus
  - ABS Systems
- DC/DC Converters and Off-line UPS
- Primary Switch for 24V and 48V Systems
- High Current Switching Applications

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ unless otherwise specified) | Characteristic Values |      |                      |
|--------------|---|-----------------------|------|----------------------|
|              |   | Min.                  | Typ. | Max.                 |
| $BV_{DSS}$   | $V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$                          | 75                    |      | V                    |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$                               | 2.0                   |      | V                    |
| $I_{GSS}$    | $V_{GS} = \pm 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$                      |                       |      | $\pm 200 \text{ nA}$ |
| $I_{DSS}$    | $V_{DS} = V_{DSS}$  |                       |      | 5 $\mu\text{A}$      |
|              | $V_{GS} = 0 \text{ V}$ $T_J = 150^\circ\text{C}$                          |                       |      | 250 $\mu\text{A}$    |
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}$ , $I_D = 25 \text{ A}$ , Notes 1, 2               | 3.9                   | 4.5  | m $\Omega$           |

| Symbol  | Test Conditions   | Characteristic Values |      |                        |
|---|---|-----------------------|------|------------------------|
|   |   | Min.                  | Typ. | Max.                   |
| $(T_J = 25^\circ\text{C}$ unless otherwise specified) |   |                       |      |                        |
| $g_{fs}$  | $V_{DS} = 10\text{ V}; I_D = 60\text{ A}$ , Note 1              | 75                    | 120  | S                      |
| $C_{iss}$   |   |                       | 7700 | pF                     |
| $C_{oss}$   | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$   |                       | 1100 | pF                     |
| $C_{rss}$   |   |                       | 230  | pF                     |
| $t_{d(on)}$   | <b>Resistive Switching Times</b>                                |                       | 29   | ns                     |
| $t_r$   | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 25\text{ A}$ |                       | 65   | ns                     |
| $t_{d(off)}$  | $R_G = 3.3\ \Omega$ (External)                                  |                       | 55   | ns                     |
| $t_f$   |   |                       | 47   | ns                     |
| $Q_{g(on)}$   |   |                       | 165  | nC                     |
| $Q_{gs}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 25\text{ A}$ |                       | 40   | nC                     |
| $Q_{gd}$  |   |                       | 50   | nC                     |
| $R_{thJC}$  |   |                       |      | $0.31^\circ\text{C/W}$ |
| $R_{thCH}$  | TO-220  | 0.50                  |      | $^\circ\text{C/W}$     |

### Source-Drain Diode

| Symbol   | Test Conditions  | Characteristic Values |      |       |
|--|--|-----------------------|------|-------|
|  |  | Min.                  | Typ. | Max.  |
| $T_J = 25^\circ\text{C}$ unless otherwise specified) |  |                       |      |       |
| $I_S$  | $V_{GS} = 0\text{ V}$  |                       |      | 220 A |
| $I_{SM}$   | Pulse width limited by $T_{JM}$  |                       |      | 600 A |
| $V_{SD}$   | $I_F = 25\text{ A}, V_{GS} = 0\text{ V}$ , Note 1  |                       |      | 1.0 V |
| $t_{rr}$   | $I_F = 25\text{ A}, -di/dt = 100\text{ A}/\mu\text{s}$<br>$V_R = 40\text{ V}, V_{GS} = 0\text{ V}$ |                       | 80   | ns    |

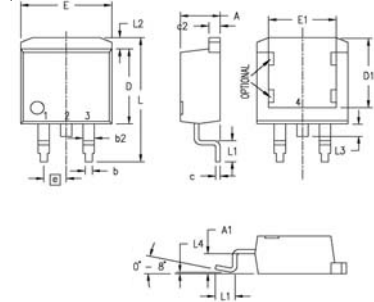
- Notes: 1. Pulse test,  $t \leq 300\ \mu\text{s}$ , duty cycle  $d \leq 2\%$ ;  
2. On through-hole packages,  $R_{DS(on)}$  Kelvin test contact location must be 5 mm or less from the package body.

### PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS reserves the right to change limits, test conditions, and dimensions.

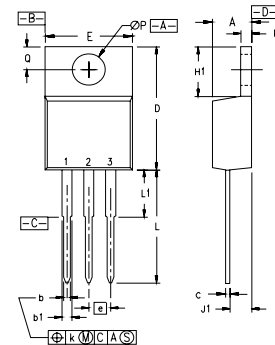
### TO-263 (IXTA) Outline



Pins: 1 - Gate 2 - Drain  
3 - Source 4, TAB - Drain

| Dim. | Millimeter |       | Inches |      |
|------|------------|-------|--------|------|
|      | Min.       | Max.  | Min.   | Max. |
| A    | 4.06       | 4.83  | .160   | .190 |
| A1   | 2.03       | 2.79  | .080   | .110 |
| b    | 0.51       | 0.99  | .020   | .039 |
| b2   | 1.14       | 1.40  | .045   | .055 |
| c    | 0.46       | 0.74  | .018   | .029 |
| c2   | 1.14       | 1.40  | .045   | .055 |
| D    | 8.64       | 9.65  | .340   | .380 |
| D1   | 7.11       | 8.13  | .280   | .320 |
| E    | 9.65       | 10.29 | .380   | .405 |
| E1   | 6.86       | 8.13  | .270   | .320 |
| e    | 2.54       | BSC   | .100   | BSC  |
| L    | 14.61      | 15.88 | .575   | .625 |
| L1   | 2.29       | 2.79  | .090   | .110 |
| L2   | 1.02       | 1.40  | .040   | .055 |
| L3   | 1.27       | 1.78  | .050   | .070 |
| L4   | 0          | 0.38  | 0      | .015 |
| R    | 0.46       | 0.74  | .018   | .029 |

### TO-220 (IXTP) Outline

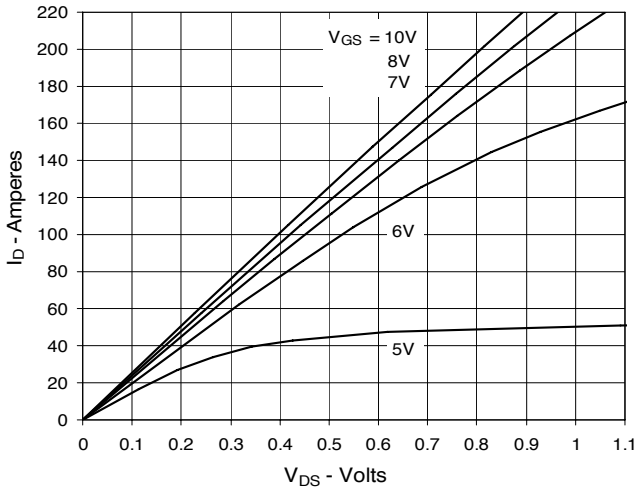


Pins: 1 - Gate 2 - Drain  
3 - Source 4, TAB - Drain

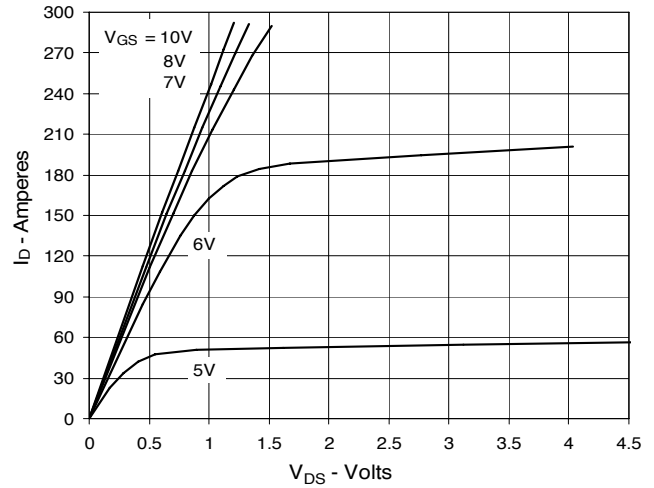
| SYM | INCHES |      | MILLIMETERS |       |
|-----|--------|------|-------------|-------|
|     | MIN    | MAX  | MIN         | MAX   |
| A   | .170   | .190 | 4.32        | 4.83  |
| b   | .025   | .040 | 0.64        | 1.02  |
| b1  | .045   | .065 | 1.15        | 1.65  |
| c   | .014   | .022 | 0.35        | 0.56  |
| D   | .580   | .630 | 14.73       | 16.00 |
| E   | .390   | .420 | 9.91        | 10.66 |
| e   | .100   | BSC  | 2.54        | BSC   |
| F   | .045   | .055 | 1.14        | 1.40  |
| H1  | .230   | .270 | 5.85        | 6.85  |
| J1  | .090   | .110 | 2.29        | 2.79  |
| k   | 0      | .015 | 0           | 0.38  |
| L   | .500   | .550 | 12.70       | 13.97 |
| L1  | .110   | .230 | 2.79        | 5.84  |
| ØP  | .139   | .161 | 3.53        | 4.08  |
| Q   | .100   | .125 | 2.54        | 3.18  |



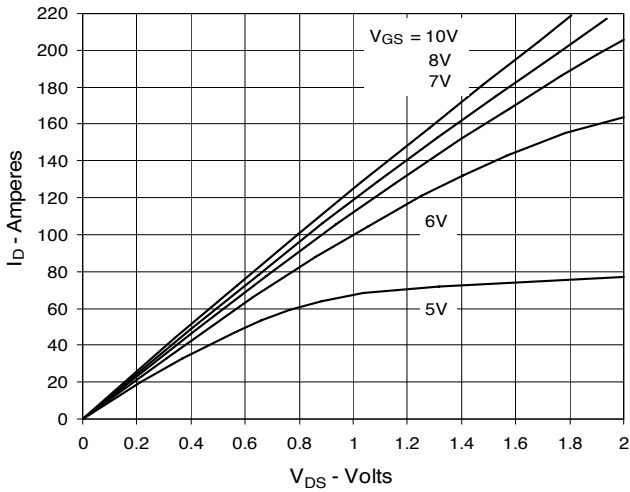
**Fig. 1. Output Characteristics @ 25°C**



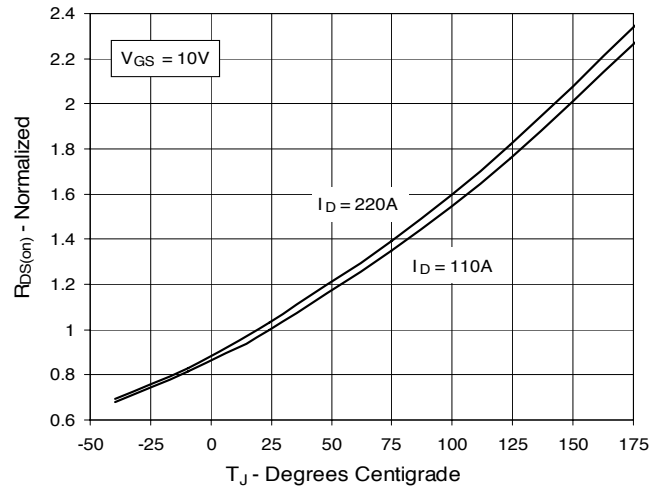
**Fig. 2. Extended Output Characteristics @ 25°C**



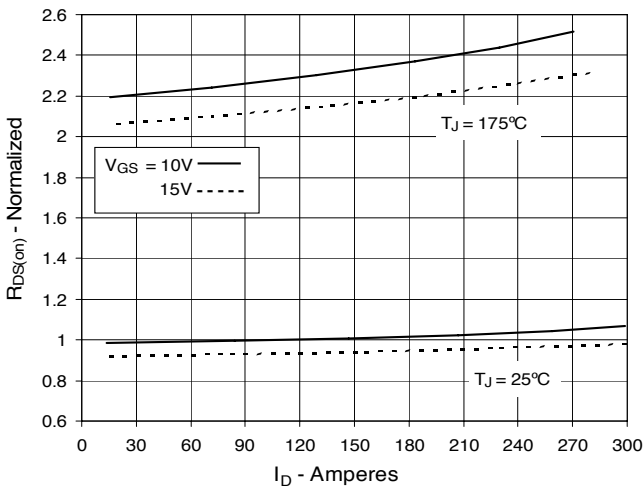
**Fig. 3. Output Characteristics @ 150°C**



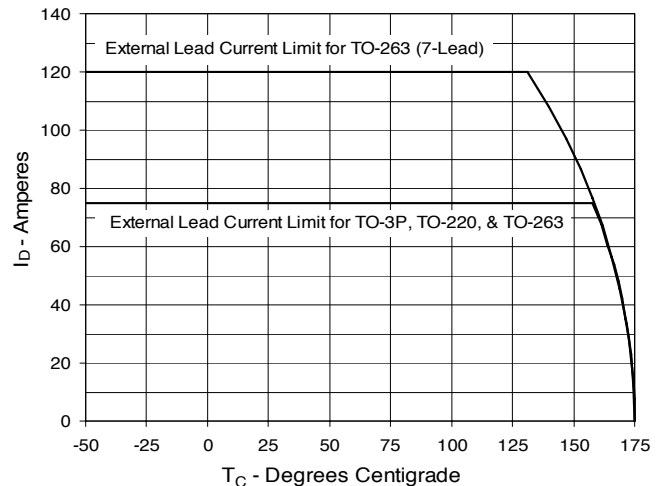
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 110\text{A}$  Value vs. Junction Temperature**



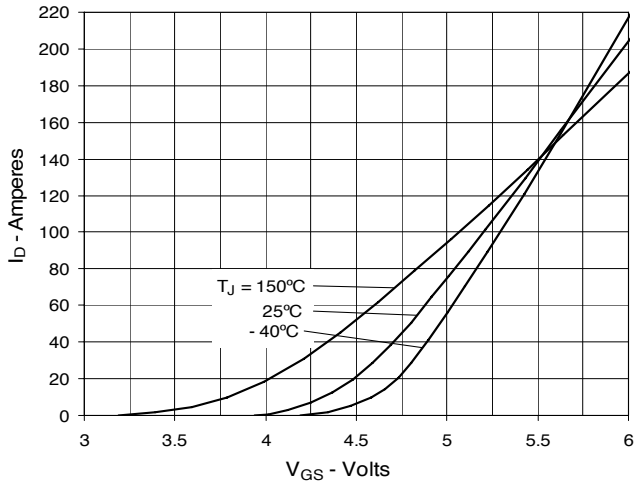
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 110\text{A}$  Value vs. Drain Current**



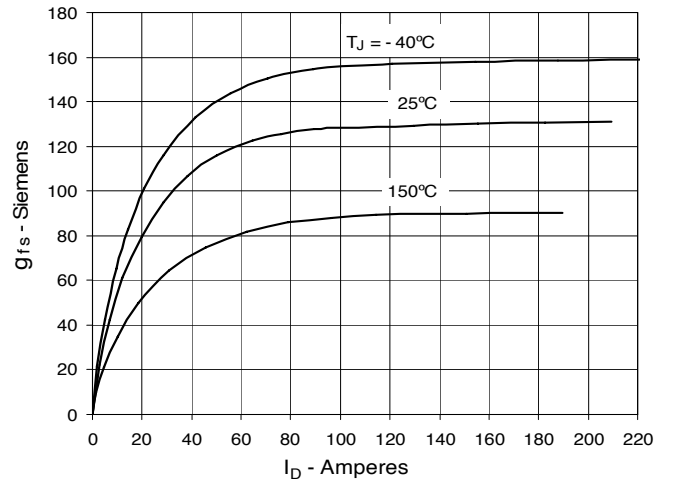
**Fig. 6. Drain Current vs. Case Temperature**



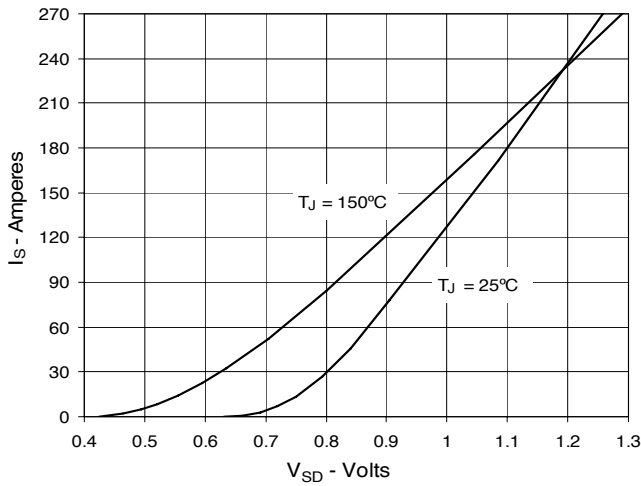
**Fig. 7. Input Admittance**



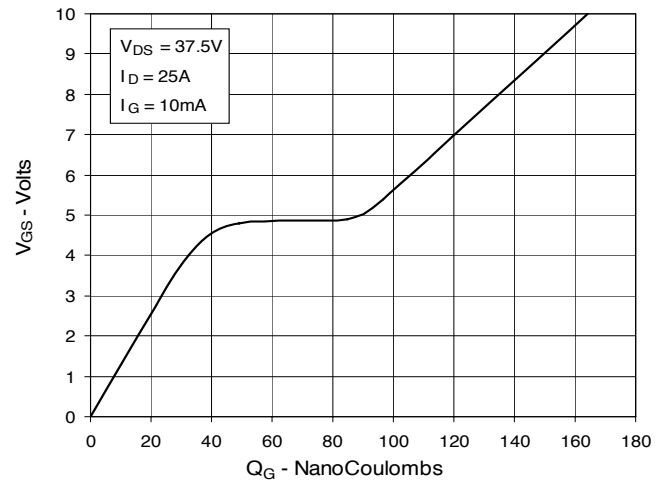
**Fig. 8. Transconductance**



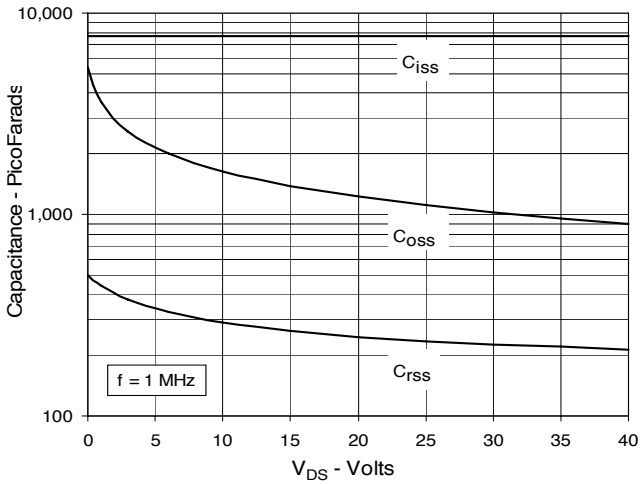
**Fig. 9. Forward Voltage Drop of Intrinsic Diode**



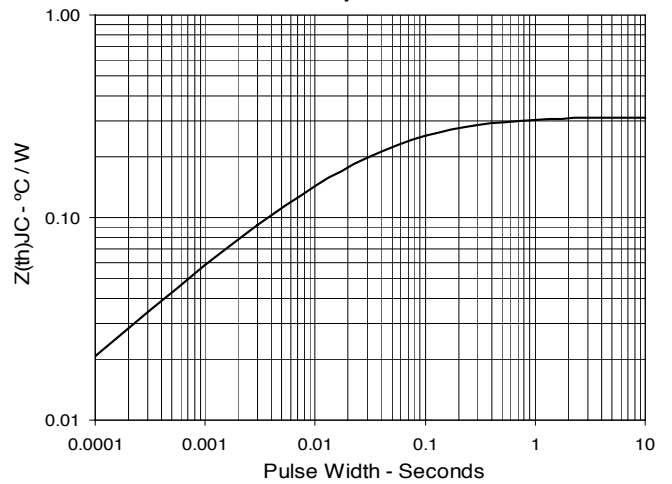
**Fig. 10. Gate Charge**



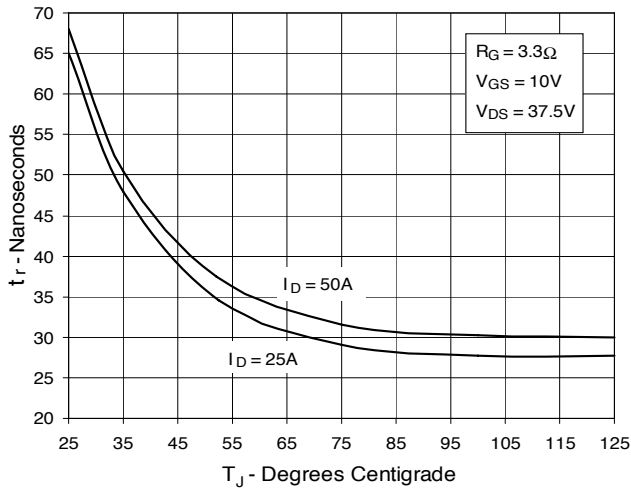
**Fig. 11. Capacitance**



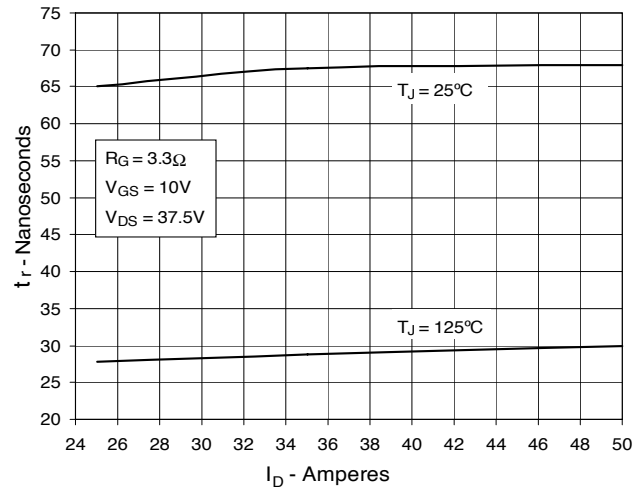
**Fig. 12. Maximum Transient Thermal Impedance**



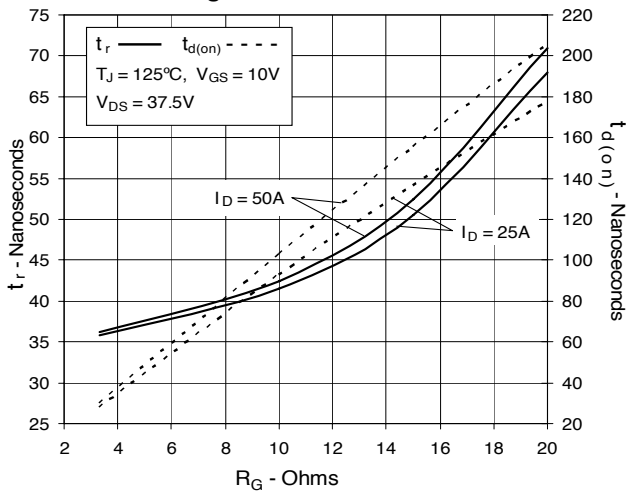
**Fig. 13. Resistive Turn-on  
Rise Time vs. Junction Temperature**



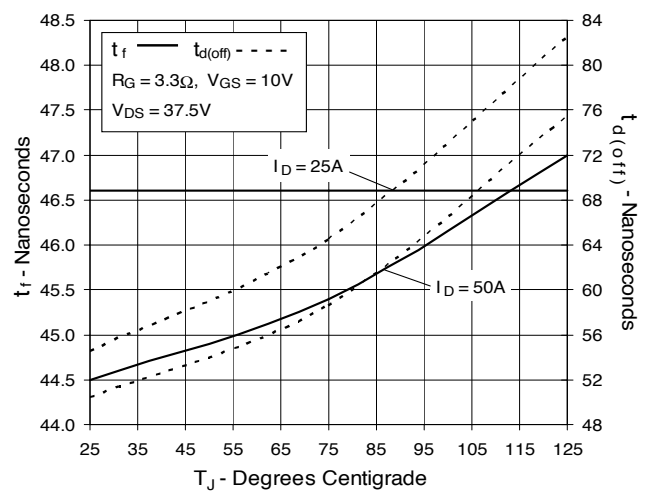
**Fig. 14. Resistive Turn-on  
Rise Time vs. Drain Current**



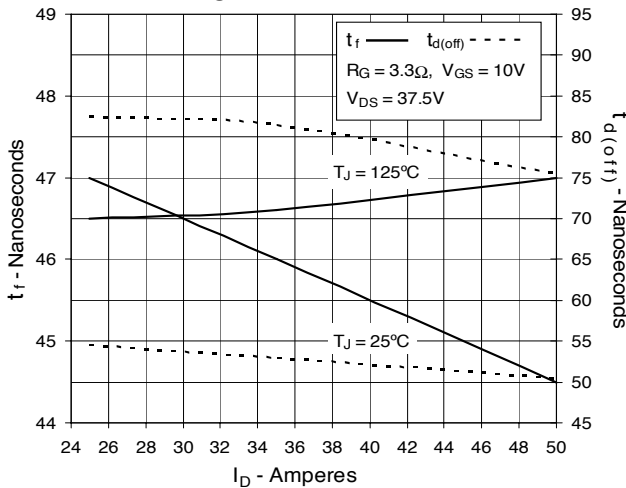
**Fig. 15. Resistive Turn-on  
Switching Times vs. Gate Resistance**



**Fig. 16. Resistive Turn-off  
Switching Times vs. Junction Temperature**



**Fig. 17. Resistive Turn-off  
Switching Times vs. Drain Current**



**Fig. 18. Resistive Turn-off  
Switching Times vs. Gate Resistance**

